

SiC Bridge Rectifier

SK20KDD12SCp

Features*

- 1200V SiC Schottky diodes
- · High frequency rectifier
- Smart pinout to ease parallel or series modules connection
- · Compact design
- One screw mounting module
- Fully compatible with other SEMITOP® Press-Fit types
- Improved thermal performance by aluminum oxide substrate
- Ultra Low inductance design
- UL recognized, file no. E63532

Typical Applications

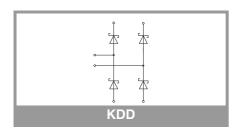
- · Solar inverter
- UPS
- Power Supply

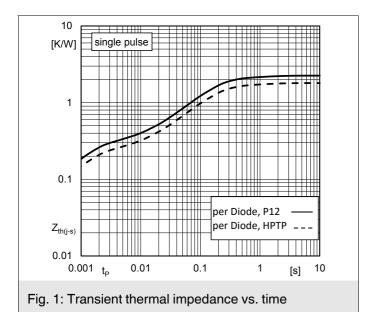
Absolute Maximum Ratings					
Symbol	Conditions		Values	Unit	
Diode 1	•		•	'	
V_{RRM}	T _j = 25 °C		1200	V	
I _F	P12	T _s = 25 °C	19	Α	
	T _j = 175 °C	T _s = 70 °C	16	Α	
I _F	HPTP / HP-PCM $T_j = 175 ^{\circ}\text{C}$	T _s = 25 °C	22	Α	
		T _s = 70 °C	18	Α	
I _{FSM}	8.3 ms, sin 180°,		33	Α	
i ² t	8.3 ms, sin 180°, T _j = 150 °C		4	A ² s	
Tj			-40 175	°C	

Absolute Maximum Ratings						
Symbol	Conditions	Values	Unit			
Module						
I _{t(RMS)}	ΔT _{terminal} at PCB joint = 30 K, per pin	35	Α			
T _{stg}	module without TIM	-40 125	°C			
V _{isol}	AC, sinusoidal, t = 1 min	2500	V			

Characteristics							
Symbol	Conditions		min.	typ.	max.	Unit	
Diode 1							
V_{F}	I _F = 10 A	T _j = 25 °C		1.40	1.60	V	
	chiplevel	T _j = 150 °C		1.80	2.10	V	
V_{F0}	ahialawal	T _j = 25 °C		0.95	1.05	V	
	chiplevel	T _j = 150 °C		0.80	0.90	V	
r _F	chiplevel	T _j = 25 °C		45	55	mΩ	
		T _j = 150 °C		100	120	mΩ	
Cj	V _R = 800 V, f = 1 MHz, T _j = 25 °C			0.042		nF	
Q _c	$V_R = 800 \text{ V}, \text{ di/dt}_{\text{off}} = 500 \text{ A/}\mu\text{s},$ $T_j = 25 \text{ °C}$			0.034		μC	
R _{th(j-s)}	per Diode, P12 (Reference)			2.25		K/W	
R _{th(j-s)}	per Diode, HPTP			1.8		K/W	

Characteristics						
Symbol	Conditions	min.	typ.	max.	Unit	
Module						
Ms	to heatsink	1.8		2	Nm	
W	weight		19		g	





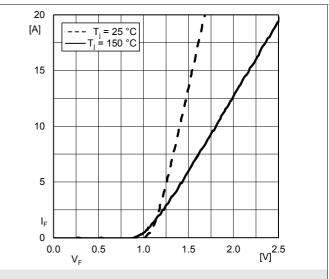


Fig. 2: Typ. Diode1 forward characteristic, incl. $R_{CC'+\,EE'}$

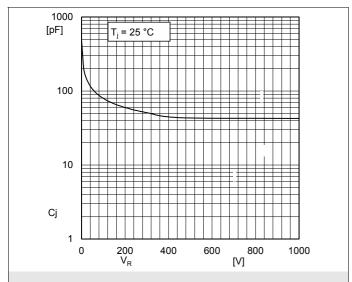
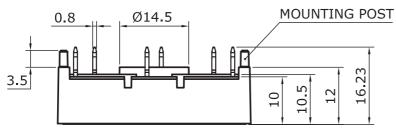
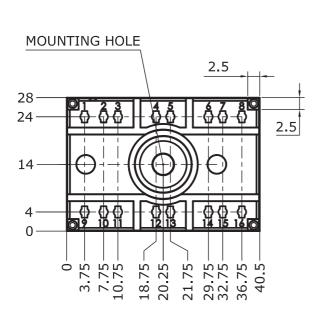


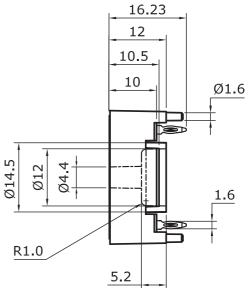
Fig. 3: Typ. capacitance-voltage charact. (1 MHz)

Dimensions: mm

Tolerance system: ISO 2768-m



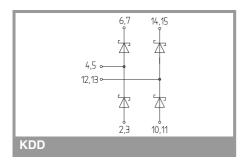




Suggested drilled hole diameter for terminal pins in the circuit board:
- refer Mounting Instruction SEMITOP® Classic

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SEMITOP 2 Press-Fit



IMPORTANT INFORMATION AND WARNINGS

This is an electrostatic discharge sensitive device (ESDS) according to international standard IEC 61340.

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